formlabs 😿

ENGINEERING RESIN

High Temp Resin

Resin for Heat Resistance

High Temp Resin offers a heat deflection temperature (HDT) of 238 °C @ 0.45 MPa, the highest among Formlabs resins. Use it to print detailed, precise prototypes with high temperature resistance.

Hot air, gas, and fluid flow

Heat resistant mounts, housings, and fixtures

Molds and inserts





FLHTAM02

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To the best of our knowledge the information contained herein is accurate. However, Formlabs, Inc. makes no warranty, expressed or implied, regarding the accuracy of these results to be obtained from the use thereof.

| Material Properties | METRIC ¹ | | | IMPERIAL ¹ | | | METHOD |
|-------------------------------------|---------------------|---|---|-----------------------|--|---|-------------|
| | Green ² | Post-Cured for 60 min at 60 °C ³ | Post-Cured for 120 min at 80 °C and 180 min at 160 °C ⁴ | Green ² | Post-Cured for 60 min at 176 °F ³ | Post-Cured for 120 min at 248 °F and 180 min at 356 °F 4 | |
| Tensile Properties | METRIC 1 | | | IMPERIAL ¹ | | | METHOD |
| Ultimate Tensile Strength | 21 MPa | 58 MPa | 49 MPa | 3031 psi | 8456 psi | 7063 psi | ASTM D638-1 |
| Tensile Modulus | 0.75 GPa | 2.8 GPa | 2.8 GPa | 109 ksi | 399 ksi | 406 ksi | ASTM D638-1 |
| Elongation at Break | 14% | 3.3% | 2.3% | 14% | 3.3% | 2.3% | ASTM D638-1 |
| Flexural Properties | METRIC ¹ | | | IMPERIAL ¹ | | | METHOD |
| Flexural Strength at Break | 24 MPa | 95 MPa | 97 MPa | 3495 psi | 13706 psi | 14097 psi | ASTM D790-1 |
| Flexural Modulus | 0.7 GPa | 2.6 GPa | 2.8 GPa | 100 ksi | 400 ksi | 406 ksi | ASTM D790-1 |
| Impact Properties | METRIC ¹ | | | IMPERIAL ¹ | | | METHOD |
| Notched Izod | 33 J/m | 18 J/m | 17 J/m | 0.61 ft-lb/in | 0.34 ft-lb/in | 0.32 ft-lb/in | ASTM D256-1 |
| Thermal Properties | METRIC 1 | | | IMPERIAL ¹ | | | METHOD |
| Heat Deflection Temp. @ 1.8 MPa | 44 °C | 78 °C | 101 °C | 111 °F | 172 °F | 214 °F | ASTM D648-1 |
| Heat Deflection Temp. @ 0.45 MPa | 49 °C | 120 °C | 238 °C | 120 °F | 248 °F | 460 °F | ASTM D648-1 |
| Thermal Expansion | 118 µm/m/°C | 80 μm/m/°C | 75 µm/m/°C | 41 µin/in/°F | 44 μin/in/°F | 41 µin/in/°F | ASTM E831-1 |

SOLVENT COMPATIBILITY

Percent weight gain over 24 hours for a printed and post-cured 1 x 1 x 1 cm cube immersed in respective solvent:

| Solvent | 24 hr size gain, % | 24 hr weight gain, % | Solvent | 24 hr size gain, % | 24 hr weight gain, % | |
|--------------------------------------|-----------------------|-------------------------|---|-----------------------|-------------------------|--|
| Acetic Acid 5% | < 1 | < 1 | Mineral oil (Light) | <1 | <1 | |
| Acetone | < 1 | 2 | Mineral oil (Heavy) | < 1 | < 1 | |
| Bleach ~5% NaOCl | < 1 | < 1 | Salt Water (3.5% NaCl) | <1 | < 1 | |
| Butyl Acetate | < 1 | < 1 | Skydrol 5 | <1 | 1.1 | |
| Diesel Fuel | < 1 | < 1 | Sodium Hydroxide solution (0.025% PH 10) | < 1 | < 1 | |
| Diethyl glycol Mon- omethyl Ether | < 1 | 1 | Strong Acid (HCl conc) | 1.2 | < 1 | |
| Hydraulic Oil | < 1 | < 1 | Tripropylene glycol monomethyl ether | < 1 | <1 | |
| Hydrogen peroxide (3%) | < 1 | < 1 | Water | < 1 | < 1 | |
| Isooctane (aka gasoline) | < 1 | < 1 | Xylene | < 1 | <1 | |
| Isopropyl Alcohol | < 1 | < 1 | | | | |

Material properties can vary with part geometry, print orientation, print settings, and temperature.

² Data was obtained from green parts, printed using a Form 2, 100 µm, High Temp settings, washed for 5 minutes in Form Wesh and air dired without post cure.

3 Data was obtained from parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 60 minutes. The micro and additional form the without post cure.

3 Data was obtained from parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 minutes puts an additional form parts printed using a Form 2, 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured with Form Cure at 60 °C for 100 micron, High Temp settings, and post-cured wit